12-V General Purpose Analog Switch

Features

- Analog Switch Voltage: 3.3 V, 5 V, 10 V, ±5 V
- Low On-State Resistance:
  - Typical 50 Ω at V_S = ±4.5 V or 9 V
  - Typical 60 Ω at V_S = 4.5 V
  - Typical 300 Ω at V_S = 3 V
- Bandwidth: 200 MHz
- Fast Switching Time: t_{ON} = 60 ns, t_{OFF} = 50 ns
- Break-Before-Make Switching
- Operating Temperature Range: –40°C to 125°C

Applications

- Industry Control Systems
- Battery-Powered Systems
- Audio Signal Routing
- Instrumentation

Description

The TPW4051 is a single-pole octal-throw (SP8T) analog switch, suitable for use in analog or digital 8:1 multiplexer/demultiplexer applications. The switch features three digital select inputs (S0, S1, and S2), eight independent inputs/outputs (An), a common input/output (A), and a digital enable input ($\overline{E}$). When $\overline{E}$ is high, the switch is turned off.

The device is designed on an enhanced process that provides lower power dissipation and high switching speed. The device operates equally well as either multiplexers or demultiplexers, and has an input range that extends to the supplies. All channels exhibit break-before-make switching action, preventing momentary shorting when switching channels.

Table of Contents

Switch Selection Guide

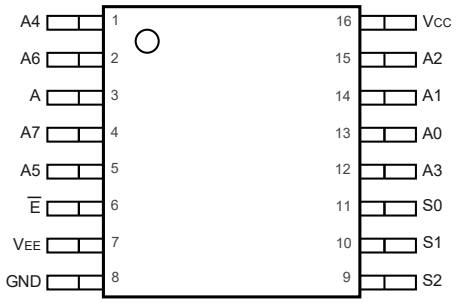
Product	Switch Configuration	Supply Voltage (V)	R_{ON} (Ω)	Bandwidth (MHz)	Package
TPW4051	8:1	12	50	200	SOP16, TSSOP16, QFN3X3-16
TPW4052	(4:1) × 2	12	50	200	SOP16, TSSOP16
TPW4053	(2:1) × 3	12	50	200	SOP16, TSSOP16
TPW3111	1:1	5.5	1	100	SOT353 (SC70-5)
TPW3115	1:1	5.5	5	250	SOT353 (SC70-5), SOT23-5
TPW4157	2:1	5.5	1	100	SOT363 (SC70-6)
TPW3157A	2:1	5.5	2	100	SOT363 (SC70-6)
TPW3221	(2:1) × 2	5.5	1	100	MSOP10
TPW3223	(2:1) × 2	5.5	1	100	QFN1.4X1.8-10

Revision History

Date	Revision	Notes
2018-08-08	Rev.Pre.0	Pre-released version.
2019-03-04	Rev.A.0	Initial version.
2019-10-02	Rev.A.1	Changed the value of HBM: from 2 kV to 1 kV.
2019-12-25	Rev.A.2	Corrected the test conditions of ΔR_{ON} (On Resistance Match between Channels) and switch leakage to follow the product test (Product test is not changed): • Corrected all "0 V" to "V_{EE}"; • Removed the ΔR_{ON} at 3 to 3.6 V V_{CC}; • Changed the ΔR_{ON} at 9 to 11 V V_{CC}: from V_{IS} = 3.5 V to V_{IS} = 1 V; • Changed the ΔR_{ON} at 4.5 to 5.5 V V_{CC}, V_{EE} = −4.5 V to 5.5 V: from V_{IS} = 3.5 V to V_{IS} = −3.5 V.
2020-01-14	Rev.A.3	Corrected the "P0" information of TR in Tape and Reel Information.
2020-11-26	Rev.A.4	Corrected the Quantity of TPW4051-QF4R in Order Information: from 3000 to 4000.
2022-04-21	Rev.A.5	Added the Thermal Information. Updated the high POD of the QFN3x3-16 package.
2024-12-04	Rev.A.6	Added a new part number: TPW4051-SOBR. The following updates are all about the new datasheet formats or typos, and the actual product remains unchanged. Updated to a new datasheet format. Updated the Tape and Reel Information. Updated the Package Outline Dimensions.
2025-11-27	Rev.A.7	Added the thermal pad description in the Pin Configuration and Functions. The actual product remains unchanged.

Pin Configuration and Functions

TPW4051
SOP16/TSSOP16/WSOP16
Top View



TPW4051
QFN3X3-16
Top View

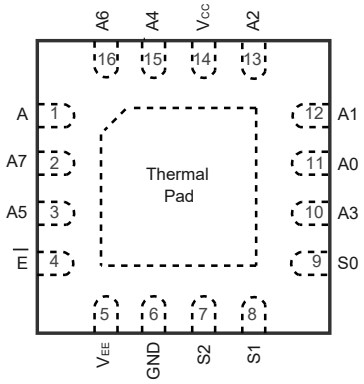


Table 1. Pin Functions: TPW4051

Pin No.			Name	I/O	Description
SOP16	TSSOP16	QFN3X3-16			
1	1	15	A4	I/O	Channel 4 input or output
2	2	16	A6	I/O	Channel 6 input or output
3	3	1	A	I/O	Common input or output
4	4	2	A7	I/O	Channel 7 input or output
5	5	3	A5	I/O	Channel 5 input or output
6	6	4	$\overline{E}$	I	Enable switch, active low
7	7	5	V_{EE}		Negative power input
8	8	6	GND		Ground
9	9	7	S2	I	Control input
10	10	8	S1	I	Control input
11	11	9	S0	I	Control input
12	12	10	A3	I/O	Channel 3 input or output
13	13	11	A0	I/O	Channel 0 input or output
14	14	12	A1	I/O	Channel 1 input or output
15	15	13	A2	I/O	Channel 2 input or output
16	16	14	V_{CC}		Positive power input
-	-	-	Thermal Pad		Thermal pad. The thermal pad is recommended to be left float or connected to V_{EE}.

Table 2. Functional Table

$\overline{E}$, Enable	S2	S1	S0	ON Channel
L	L	L	L	A0
L	L	L	H	A1
L	L	H	L	A2
L	L	H	H	A3
L	H	L	L	A4
L	H	L	H	A5
L	H	H	L	A6
L	H	H	H	A7
H	X	X	X	None

(1) X = Don't care.

Specifications

Absolute Maximum Ratings (1)

Parameter		Min	Max	Unit
	Supply Voltage, V_{CC} − V_{EE}	−0.5	13	V
	Supply Voltage, V_{CC} − GND	−0.5	13	V
	Supply Voltage, V_{EE} − GND	−6.5	0.5	V
	Analog Switch Voltage	V_{EE} − 0.5	V_{CC} + 0.5	V
	Analog Switch Current	−25	25	mA
	Analog Switch Diode Current	−20	20	mA
	Digital Input Voltage, $\overline{E}$, S2, S1, S0	GND	V_{CC} + 0.5	V
	Digital Input Diode Current	−20	20	mA
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range	–65	150	°C
T_L	Lead Temperature (Soldering, 10 sec)		260	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

ESD, Electrostatic Discharge Protection

Symbol	Parameter	Condition	Minimum Level	Unit
HBM	Human Body Model ESD	ANSI/ESDA/JEDEC JS-001 (1)	1	kV
CDM	Charged Device Model ESD	ANSI/ESDA/JEDEC JS-002 (2)	1	kV

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

Thermal Information

Package Type	θ_{JA}	θ_{JC}	Unit
SOP16	100	50	°C/W
TSSOP16	150	60	°C/W
QFN3X3-16	65	41	°C/W

Recommended Operating Conditions (1)

All test conditions: over operating temperature range, unless otherwise noted.

Parameter		Min	Max	Unit
	Supply Voltage, V_{CC} − V_{EE}	3	12	V
	Supply Voltage, V_{CC} – GND (2)	3	12	V
	Supply Voltage, V_{EE} – GND (2)	−6	0	V
	Select Input Voltage	0	V_{CC}	V
	Input Transition Rise-and-Fall Rate		100	ns/V
	Switch I/O Port Voltage	V_{EE}	V_{CC}	V
T_A	Operating Temperature Range	–40	125	°C

(1) The select input must be held high or low, and it must not float.
(2) The voltage of V_{CC}, V_{EE} needs to be within the range of V_{CC} − V_{EE}.

Electrical Characteristics

All test conditions: single supply, V_{CC} = 4.5 V to 5.5 V, V_{EE} = 0 V, GND = 0 V, unless otherwise noted.

Symbol	Parameter	Conditions	V_{CC} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
Power Supply								
I_{CC}	Quiescent Supply Current	V_{IN} = V_{EE} or V_{CC}	5.5	4	6	8	Max	μA
Digital Input								
V_{IH}	Input Voltage High				2.0	2.0	Min	V
V_{IL}	Input Voltage Low				0.8	0.8	Max	V
I_{IN}	Control Input Leakage	V_{IN} = 0 V or V_{CC}	5.5	±0.4	±1	±1	Max	μA
Analog Switch								
R_{ON}	(1)	I_{OUT} = 1 mA, V_{IS} = V_{EE} or V_{CC}	4.5	60			Typ	Ω
R_{ON}		I_{OUT} = 1 mA, V_{IS} = V_{EE} or V_{CC}	4.5	100	130	150	Max	Ω
ΔR_{ON}	On Resistance Match between Channels	I_{OUT} = 1 mA, V_{IS} = 2.5 V	4.5	20	30	35	Max	Ω
$R_{FLAT(ON)}$	On Resistance Flatness	I_{OUT} = 1 mA	4.5	60	80	80	Max	Ω
$I_{CH(OFF)}$	Switch OFF Leakage Current on Channel	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	5.5	±0.4	±1	±1	Max	μA
$I_{COM(OFF)}$	Switch OFF Leakage Current on Common	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	5.5	±0.4	±4	±4	Max	μA
$I_{(ON)}$	Switch ON Leakage Current	V_{IS} = V_{EE} or V_{CC}	5.5	±0.4	±4	±4	Max	μA
Dynamic Characteristics								
t_{PHL}, t_{PLH}	Switch IN to OUT Time (1)	C_L = 50 pF	4.5	5			Typ	ns
t_{ON}	Switch Turn-on Time	C_L = 50 pF	4.5	60			Max	ns
t_{OFF}	Switch Turn-off Time	C_L = 50 pF	4.5	50			Max	ns
	Off Isolation (1)	f = 1 MHz, R_L = 50 Ω, C_L = 10 pF	5	−70			Typ	dB
	Crosstalk in Channel (1)	f = 1 MHz, R_L = 50 Ω, C_L = 10 pF	5	−70			Typ	dB
	Crosstalk in Control (1)	Between control and any switch; R_L = 600 Ω; f = 1 MHz; E or Sn square wave between V_{CC} and GND	5	110			Typ	mV
BW	Bandwidth (1)	R_L = 50 Ω	5	200			Typ	MHz

Symbol	Parameter	Conditions	V_{CC} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
THD	Total Harmonic Distortion (1)	R_L = 10 kΩ, f = 1 kHz	5	0.05			Typ	%
Capacitance								
C_{IN}	Switch Input Capacitance (1)		5	5			Typ	pF
C_{COM}	Common Output Capacitance (1)		5	25			Typ	pF
C_{PD}	Power Dissipation Capacitance (1)		5	50			Typ	pF

(1) The test data is based on bench tests and design simulation.

Electrical Characteristics (Continued)

All test conditions: single supply, V_{CC} = 3 V to 3.6 V, V_{EE} = 0 V, GND = 0 V, unless otherwise noted.

Symbol	Parameter	Conditions	V_{CC} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
Power Supply								
I_{CC}	Quiescent Supply Current	V_{IN} = V_{EE} or V_{CC}	3.6	4	6	8	Max	μA
Digital Input								
V_{IH}	Input Voltage High				2.0	2.0	Min	V
V_{IL}	Input Voltage Low				0.8	0.8	Max	V
I_{IN}	Control Input Leakage	V_{IN} = 0 V or V_{CC}	3.6		±1	±1	Max	μA
Analog Switch								
R_{ON}	(1)	I_{OUT} = 1 mA, V_{IS} = V_{EE} or V_{CC}	3	300			Typ	Ω
$R_{FLAT(ON)}$	On Resistance Flatness (1)	I_{OUT} = 1 mA	3	100			Typ	Ω
$I_{CH(OFF)}$	Switch OFF Leakage Current on Channel	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	3.6	±0.4	±1	±1	Max	μA
$I_{COM(OFF)}$	Switch OFF Leakage Current on Common	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	3.6	±0.4	±4	±4	Max	μA
$I_{(ON)}$	Switch ON Leakage Current	V_{IS} = V_{EE} or V_{CC}	3.6	±0.4	±4	±4	Max	μA
Dynamic Characteristics								
t_{PHL}, t_{PLH}	Switch IN to OUT Time (1)	C_L = 50 pF	3	5			Typ	ns
t_{ON}	Switch Turn-on Time (1)	C_L = 50 pF	3	70			Typ	ns
t_{OFF}	Switch Turn-off Time (1)	C_L = 50 pF	3	60			Typ	ns
	Off Isolation (1)	f = 1 MHz, R_L = 50 Ω, C_L = 10 pF	3.3	−70			Typ	dB
	Crosstalk (1)	f = 1 MHz, R_L = 50 Ω, C_L = 10 pF	3.3	−70			Typ	dB
	Crosstalk in Control (1)	Between control and any switch; R_L = 600 Ω; f = 1 MHz; E or Sn square wave between V_{CC} and GND	3.3	110			Typ	mV
BW	Bandwidth (1)	R_L = 50 Ω	3.3	100			Typ	MHz
THD	Total Harmonic Distortion (1)	R_L = 10 kΩ, f = 1 kHz	3.3	0.2			Typ	%
Capacitance								
C_{IN}	Switch Input Capacitance (1)		3.3	5			Typ	pF
C_{COM}	Common Output Capacitance (1)		3.3	25			Typ	pF

Symbol	Parameter	Conditions	V_{CC} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
C_{PD}	Power Dissipation Capacitance (1)		3.3	50			Typ	pF

(1) The test data is based on bench tests and design simulation.

Electrical Characteristics (Continued)

All test conditions: single supply, V_{CC} = 9 V to 11 V, V_{EE} = 0 V, GND = 0 V, unless otherwise noted.

Symbol	Parameter	Conditions	V_{CC} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
Power Supply								
I_{CC}	Quiescent Supply Current	V_{IN} = V_{EE} or V_{CC}	9	8	12	16	Max	μA
Digital Input								
V_{IH}	Input Voltage High				2.4	2.4	Min	V
V_{IL}	Input Voltage Low				0.8	0.8	Max	V
I_{IN}	Control Input Leakage	V_{IN} = 0 V or V_{CC}	11	±0.4	±1	±1	Max	μA
Analog Switch								
R_{ON}	(1)	I_{OUT} = 1 mA, V_{IS} = V_{EE} or V_{CC}	9	50			Typ	Ω
R_{ON}		I_{OUT} = 1 mA, V_{IS} = V_{EE} or V_{CC}	9	80	95	105	Max	Ω
ΔR_{ON}	On Resistance Match between Channels	I_{OUT} = 1 mA, V_{IS} = 1 V	9	15	25	30	Max	Ω
$R_{FLAT(ON)}$	On Resistance Flatness	I_{OUT} = 1 mA	9	30	40	40	Max	Ω
$I_{CH(OFF)}$	Switch OFF Leakage Current on Channel	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	11	±0.4	±1	±1	Max	μA
$I_{COM(OFF)}$	Switch OFF Leakage Current on Common	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	11	±0.4	±4	±4	Max	μA
$I_{(ON)}$	Switch ON Leakage Current	V_{IS} = V_{EE} or V_{CC}	11	±0.4	±4	±4	Max	μA
Dynamic Characteristics								
t_{PHL}, t_{PLH}	Switch IN to OUT Time (1)	C_L = 50 pF	9	5			Typ	ns
t_{ON}	Switch Turn-on Time	C_L = 50 pF	9	60			Max	ns
t_{OFF}	Switch Turn-off Time	C_L = 50 pF	9	50			Max	ns
	Off Isolation (1)	f = 1 MHz, R_L = 50 Ω, C_L = 10 pF	10	−70			Typ	dB
	Crosstalk (1)	f = 1 MHz, R_L = 50 Ω, C_L = 10 pF	10	−70			Typ	dB
	Crosstalk in Control (1)	Between control and any switch; R_L = 600 Ω; f = 1 MHz; E or Sn square wave between V_{CC} and GND	10	220			Typ	mV
BW	Bandwidth (1)	R_L = 50 Ω	10	200			Typ	MHz

Symbol	Parameter	Conditions	V_{CC} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
THD	Total Harmonic Distortion (1)	R_L = 10 kΩ, f = 1 kHz	10	0.03			Typ	%
Capacitance								
C_{IN}	Switch Input Capacitance (1)		10	5			Typ	pF
C_{COM}	Common Output Capacitance (1)		10	25			Typ	pF
C_{PD}	Power Dissipation Capacitance (1)		10	50			Typ	pF

(1) The test data is based on bench tests and design simulation.

Electrical Characteristics (Continued)

All test conditions: dual supply, V_{CC} = 4.5 V to 5.5 V, V_{EE} = −4.5 V to 5.5 V, GND = 0 V, unless otherwise noted.

Symbol	Parameter	Conditions	V_{CC} / V_{EE} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
Power Supply								
I_{CC}	Quiescent Supply Current	V_{IN} = V_{EE} or V_{CC}	5.5/ −5.5	8	12	16	Max	μA
Digital Input								
V_{IH}	Input Voltage High				70% × V_{CC}	70% × V_{CC}	Min	V
V_{IL}	Input Voltage Low				30% × V_{CC}	30% × V_{CC}	Max	V
I_{IN}	Control Input Leakage	V_{IN} = 0 V or V_{CC}	5.5/ −5.5	±0.4	±1	±1	Max	μA
Analog Switch								
R_{ON}	(1)	I_{OUT} = 1 mA, V_{IS} = V_{EE} or V_{CC}	4.5/ −4.5	50			Typ	Ω
R_{ON}		I_{OUT} = 1 mA, V_{IS} = V_{EE} or V_{CC}	4.5/ −4.5	80	95	105	Max	Ω
ΔR_{ON}	On Resistance Match between Channels	I_{OUT} = 1 mA, V_{IS} = −3.5 V	4.5/ −4.5	15	25	30	Max	Ω
$R_{FLAT(ON)}$	On Resistance Flatness	I_{OUT} = 1 mA	4.5/ −4.5	30	40	40	Max	Ω
$I_{CH(OFF)}$	Switch OFF Leakage Current on Channel	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	5.5/ −5.5	±0.4	±1	±1	Max	μA
$I_{COM(OFF)}$	Switch OFF Leakage Current on Common	V_{IS} = V_{EE}, V_{OS} = V_{CC}; or V_{IS} = V_{CC}, V_{OS} = V_{EE}	5.5/ −5.5	±0.4	±4	±4	Max	μA
$I_{(ON)}$	Switch ON Leakage Current	V_{IS} = V_{EE} or V_{CC}	5.5/ −5.5	±0.4	±4	±4	Max	μA
Dynamic Characteristics								
t_{PHL}, t_{PLH}	Switch IN to OUT Time (1)	C_L = 50 pF	4.5/ −4.5	5			Typ	ns
t_{ON}	Switch Turn-on Time	C_L = 50 pF	4.5/ −4.5	60			Max	ns
t_{OFF}	Switch Turn-off Time	C_L = 50 pF	4.5/ −4.5	50			Max	ns
	Off Isolation (1)	f = 1 MHz, R_L = 50 Ω, C_L = 10 pF	5/−5	−70			Typ	dB
	Crosstalk (1)	f = 1 MHz, R_L = 50 Ω,	5/−5	−70			Typ	dB

Symbol	Parameter	Conditions	V_{CC} / V_{EE} (V)	25°C	−40°C to 85°C	−40°C to 125°C	Limit	Unit
		C_L = 10 pF						
	Crosstalk in Control (1)	Between control and any switch; R_L = 600 Ω; f = 1 MHz; E or Sn square wave between V_{CC} and GND	5/−5	220			Typ	mV
BW	Bandwidth (1)	R_L = 50 Ω	5/−5	200			Typ	MHz
THD	Total Harmonic Distortion (1)	R_L = 10 kΩ, f = 1 kHz	5/−5	0.03			Typ	%
Capacitance								
C_{IN}	Switch Input Capacitance (1)		5/−5	5			Typ	pF
C_{COM}	Common Output Capacitance (1)		5/−5	25			Typ	pF
C_{PD}	Power Dissipation Capacitance (1)		5/−5	50			Typ	pF

(1) The test data is based on bench tests and design simulation.

Typical Performance Characteristics

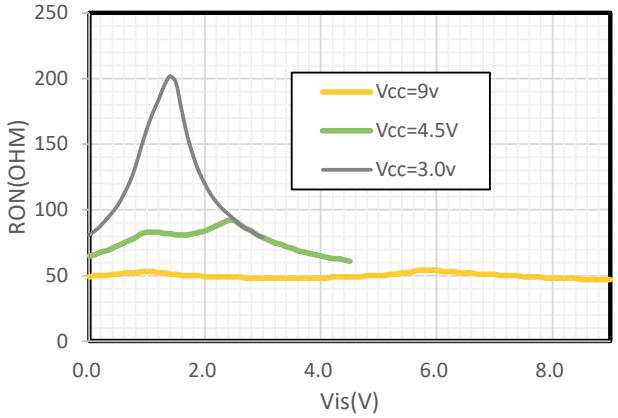


Figure 1. R_{ON} vs. V_{IS}

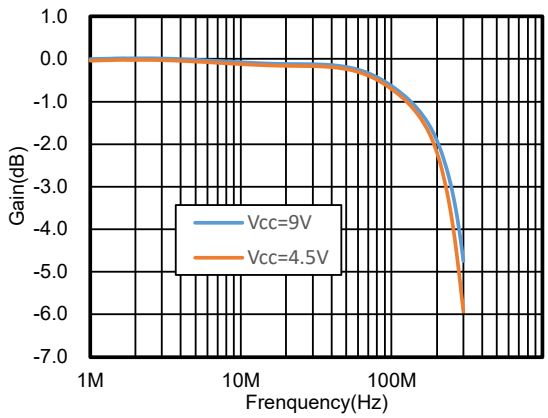
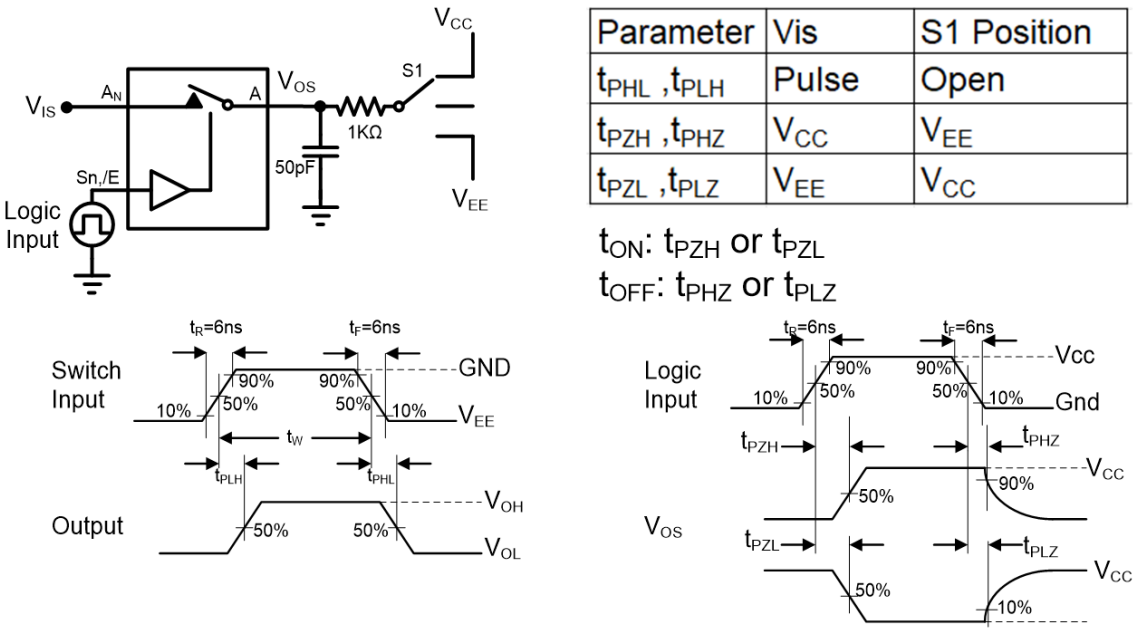


Figure 2. Bandwidth

Test Circuit and Waveforms



Parameter	Vis	S1 Position
t_{PHL} ,t_{PLH}	Pulse	Open
t_{PZH} ,t_{PHZ}	V_{CC}	V_{EE}
t_{PZL} ,t_{PLZ}	V_{EE}	V_{CC}

t_{ON}: t_{PZH} or t_{PZL}
t_{OFF}: t_{PHZ} or t_{PLZ}

Figure 3. AC Test Circuit and Test Waveforms

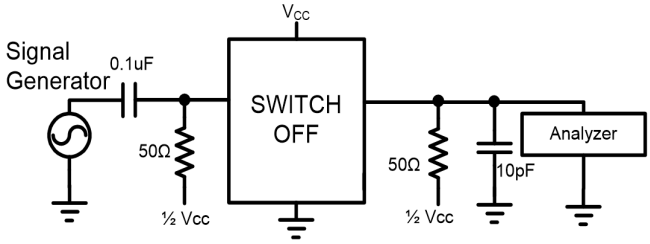


Figure 4. Off Isolation

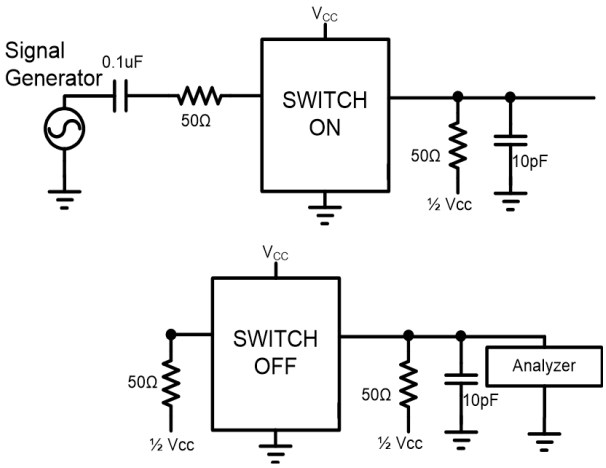


Figure 5. Crosstalk

Application and Implementation

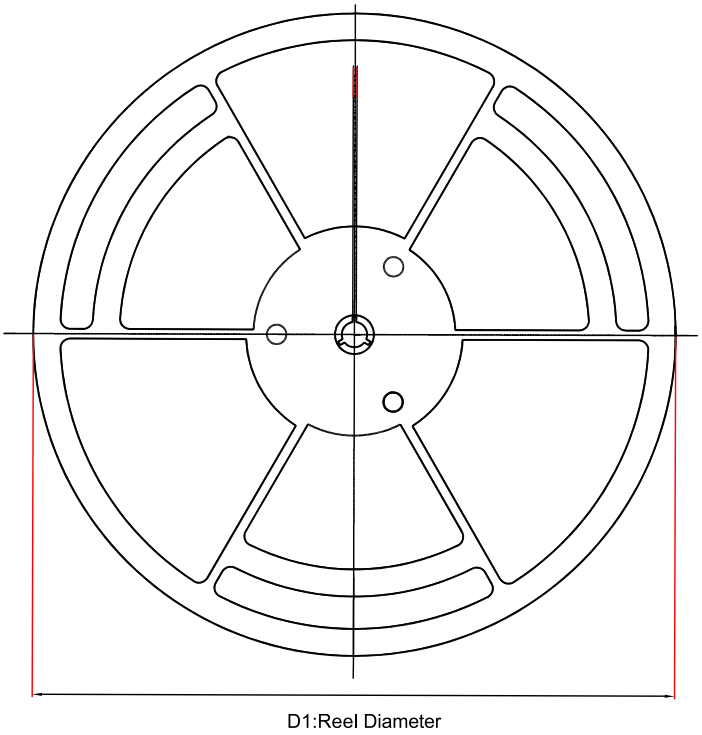
Note

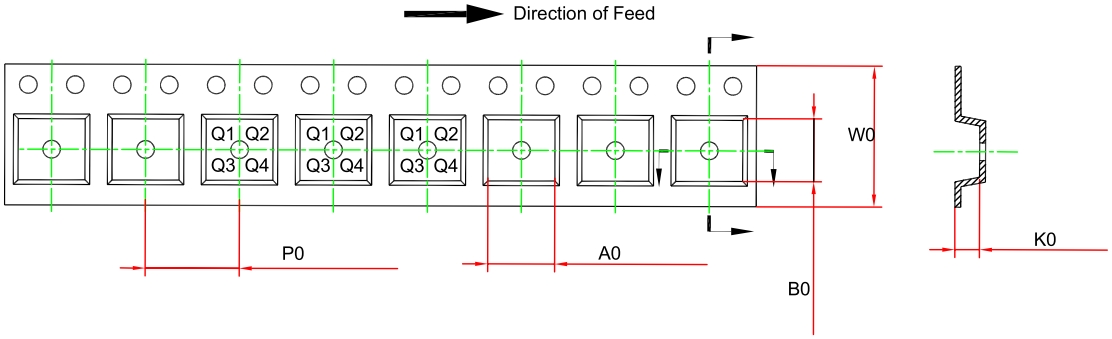
Information in the following application sections is not part of the 3PEAK's component specification and 3PEAK does not warrant its accuracy or completeness. 3PEAK's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

Application Information

A 0.1-μF bypass capacitor on V_{CC} and GND is recommended to prevent power disturbance. Another 0.1-μF bypass capacitor on V_{EE} and GND is also recommended if V_{EE} is not connected to GND.

Tape and Reel Information





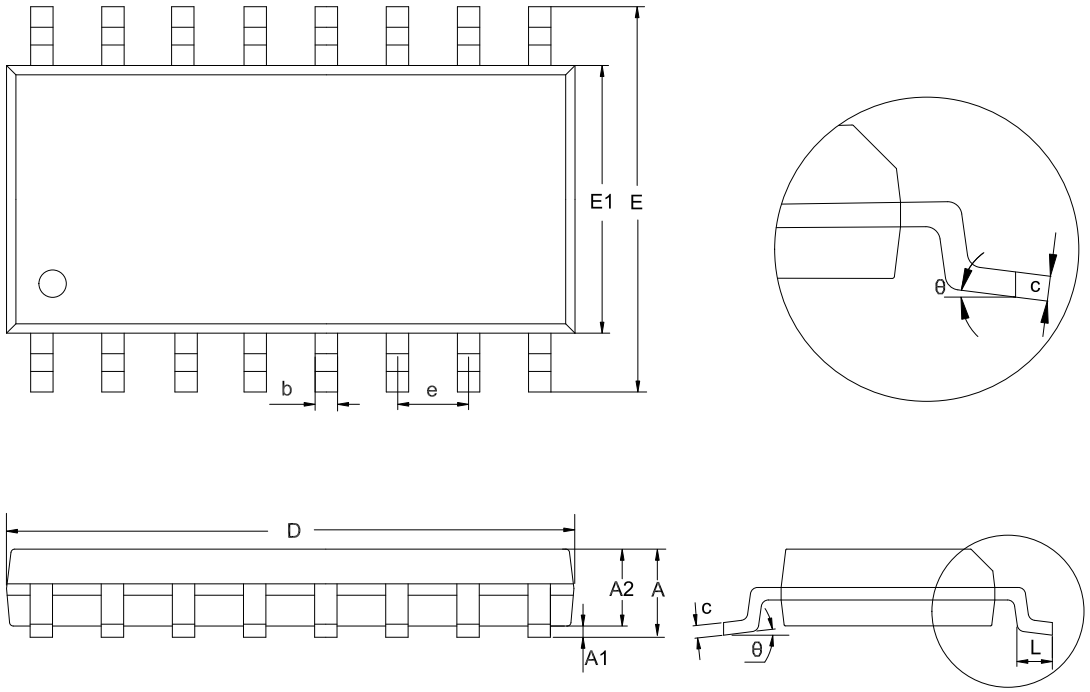
Order Number	Package	D1 (mm)	W1 (mm)	A0 (mm) (1)	B0 (mm) (1)	K0 (mm) (1)	P0 (mm)	W0 (mm)	Pin1 Quadrant
TPW4051-SR	SOP16	330	21.6	6.6	10.4	2.1	8	16	Q1
TPW4051-TR	TSSOP16	330	17.6	6.8	5.5	1.5	8	12	Q1
TPW4051-QF4R	QFN3X3-16	330	17.6	3.3	3.3	1.1	8	12	Q1
TPW4051-SOBR	WSOP16	330	21.6	10.9	10.8	3.1	12	16	Q1

(1) The value is for reference only. Contact the 3PEAK factory for more information.

Package Outline Dimensions

SOP16

Package Outline Dimensions SO3(SOP-16-A)



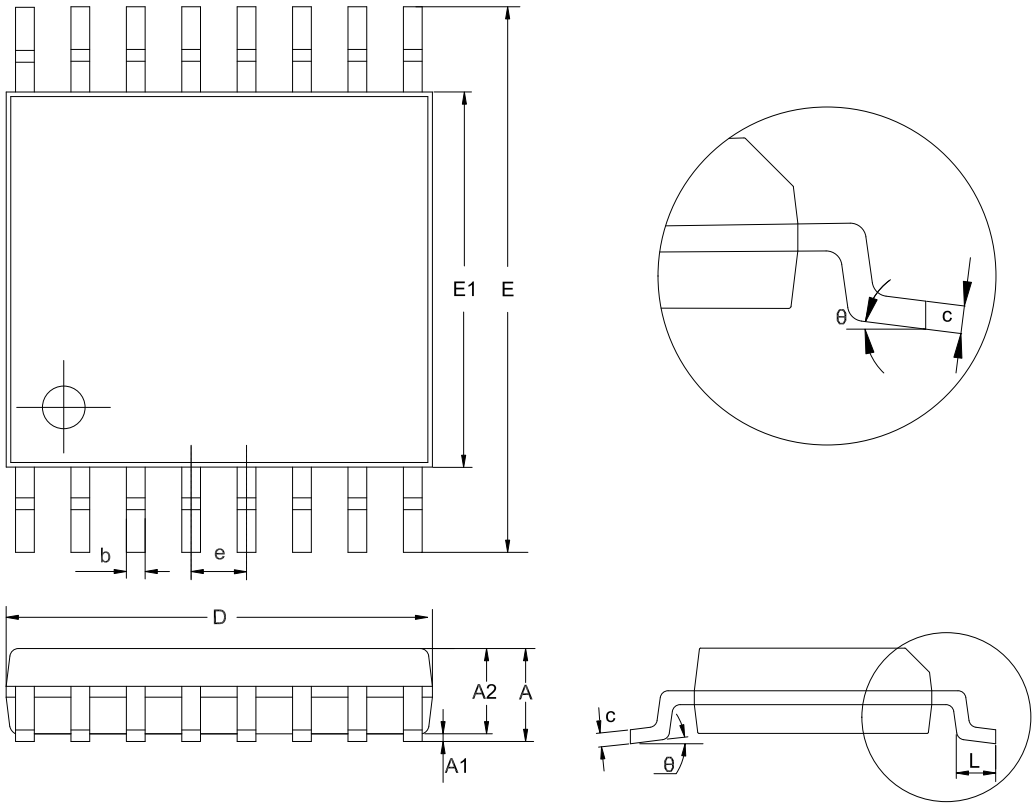
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069
A1	0.050	0.250	0.002	0.010
A2	1.300	1.600	0.051	0.063
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	9.800	10.000	0.386	0.394
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
e	1.270 BSC		0.050 BSC	
L	0.400	1.000	0.016	0.039
θ	0	8°	0	8°

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

TSSOP16

Package Outline Dimensions TS3(TSSOP-16-A)



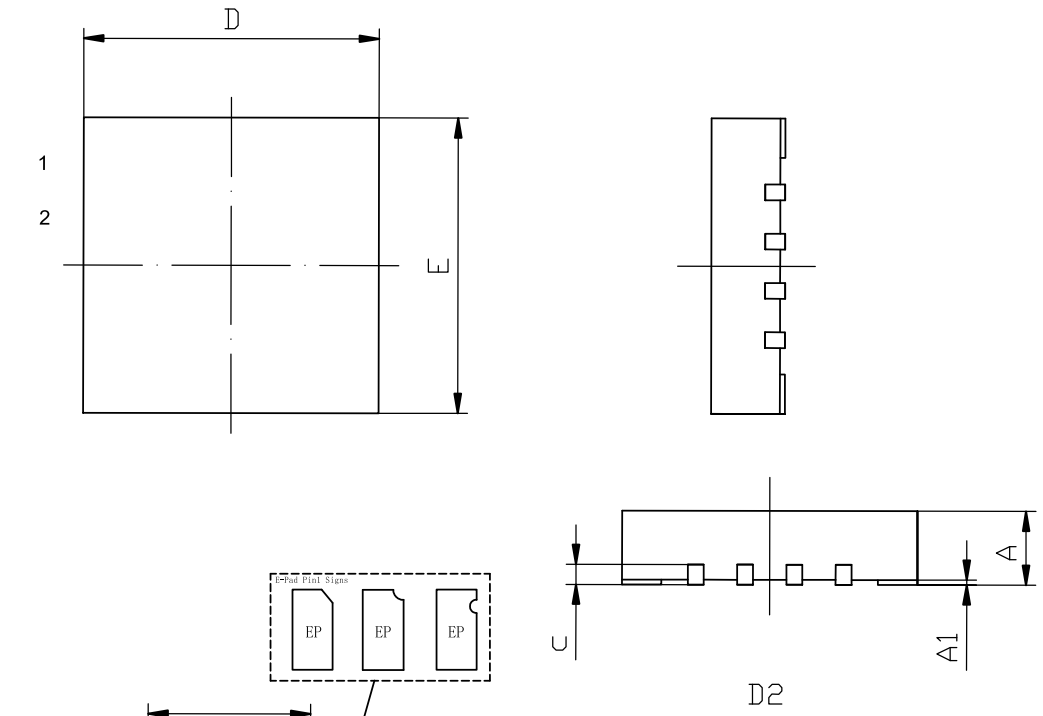
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.200	0.035	0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	4.900	5.100	0.193	0.201
E	6.200	6.600	0.244	0.260
E1	4.300	4.500	0.169	0.177
e	0.650 BSC		0.026 BSC	
L	0.450	0.750	0.018	0.030
θ	0	8°	0	8°

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

QFN3X3-16

Package Outline Dimensions QFN(QFN3X3-16-A)



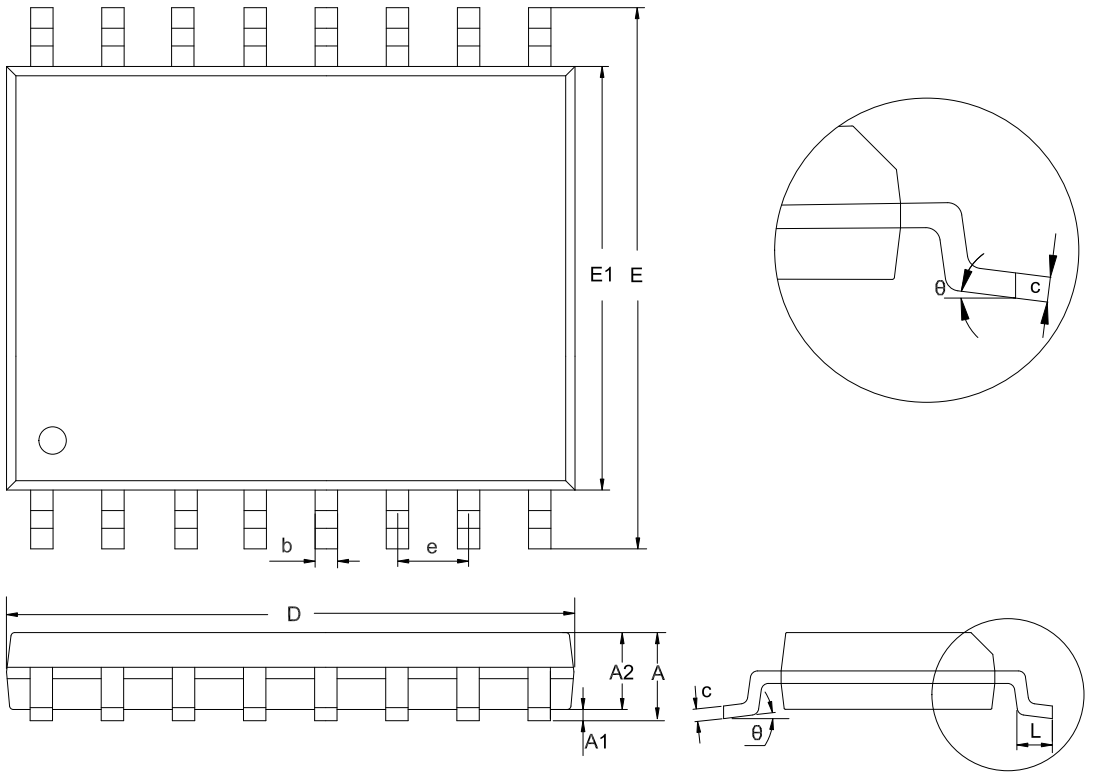
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
b	0.180	0.300	0.007	0.012
b1	0.160 REF		0.006 REF	
c	0.203 REF		0.008 REF	
D	2.900	3.100	0.114	0.122
D2	1.550	1.750	0.061	0.069
E	2.900	3.100	0.114	0.122
E2	1.550	1.750	0.061	0.069
e	0.500 BSC		0.020 BSC	
L	0.250	0.450	0.010	0.018
h	0.200	0.300	0.008	0.012

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.
3. The many types of E-pad Pin1 signs may appear in the product.

WSOP16

Package Outline Dimensions SOB(WSOP-16-A)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	2.350	2.650	0.093	0.104
A1	0.100	0.300	0.004	0.012
A2	2.250	2.350	0.089	0.093
b	0.350	0.450	0.014	0.018
c	0.200	0.290	0.008	0.011
D	10.100	10.500	0.398	0.413
E	10.100	10.600	0.398	0.417
E1	7.300	7.700	0.287	0.303
e	1.270 BSC		0.050 BSC	
L	0.500	0.850	0.020	0.033
θ	0	8°	0	8°

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

Order Information

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity	Eco Plan
TPW4051-SR	−40 to 125°C	SOP16	W4051	3	Tape and Reel, 2500	Green
TPW4051-TR	−40 to 125°C	TSSOP16	W4051	3	Tape and Reel, 3000	Green
TPW4051-QF4R	−40 to 125°C	QFN3X3-16	W4051	3	Tape and Reel, 4000	Green
TPW4051-SOBR	−40 to 125°C	WSOP16	W4051	3	Tape and Reel, 1500	Green

Green: 3PEAK defines "Green" to mean RoHS compatible and free of halogen substances.

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